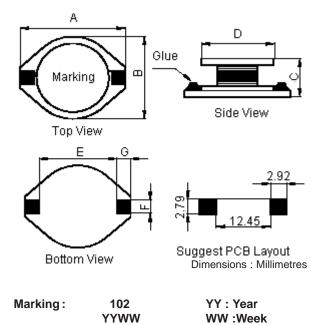
multicomp	PART NO.			REVISIONS						
		ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE
		-	А	RELEASED	Sidhu	14/2/11	Jagan	14/2/11	Farnell	28/2/11

## **Configurations and Dimensions**



L

DCR

 $\Delta T$ 

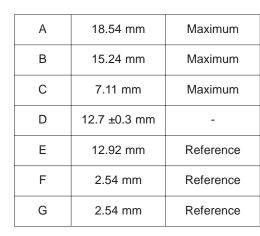
**Electrical Characteristics** 

Operating temperature: -40°C to +125°C

Test Condition 100KHz 0.25V

at 25°C

100KHz 0.25V I<sub>rms</sub> = 0.56A



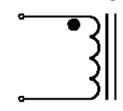
(at 25°C)

1μH ±20%

1.8Ω (Maximum)

Temperature Rise 40°C (Maximum)

#### Schematic Diagram





## Note:

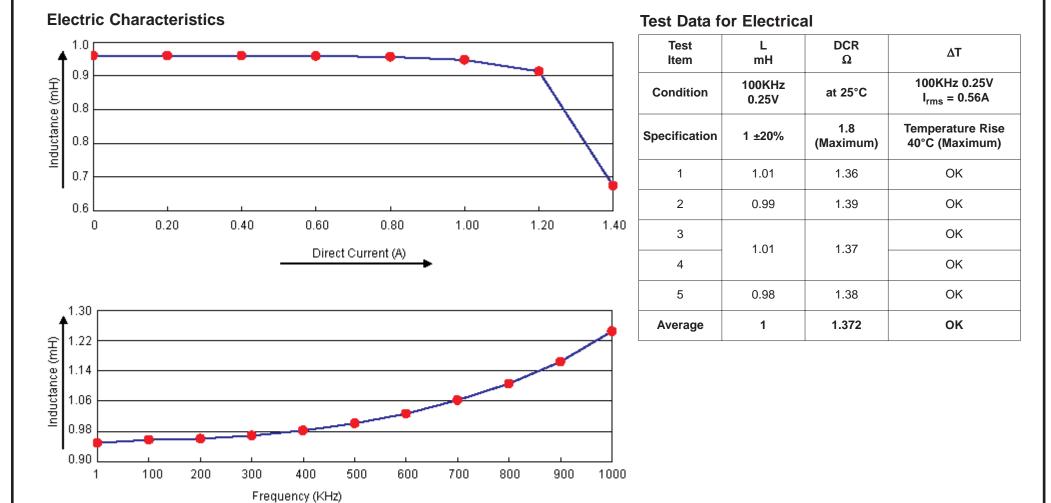
(1) Wire Ø0.23mm x 1P 2UEWF 155°C (2) 123.5TS (Reference)

#### **Test Data for Mechanical**

Test Item	A mm	B mm	C mm					G mm
Specification	18.54 (Maximum)	15.24 (Maximum)	7.11 (Maximum)	12.7 ±0.3	12.92 (Reference)	2.54 (Reference)	2.54 (Reference)	
1	18.05	14.07	6.34	12.73	13.21	2.54	2.57	
2	18.12	14.06	6.35	12.75	13.21	2.53	2.54	
3	18.08	14.05	6.33	12.74	13.26	2.5	2.56	
4	18.07	14.06	6.38	12.76	13.21	2.54	2.58	
5	18.06	14.01	6.29	12.75	13.19	2.5	2.54	
Average	18.08	14.05	6.34	12.74	13.22	2.52	2.56	

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our notice and replaces an data sheets previously supplied. The information supplied is	SPECIFIED,	CHECKED BY:	DATE:	SIZE DWG NO.		ELECTRONIC FILE	REV
data sheet should check for themselves the Information and the suitability of the prod- ucts for their purpose and not make any assumptions based on information included or	DIMENSIONS ARE	Jagan	14/02/11	Δ	M10003215	BF7330-102MU	A
	FOR REFERENCE PURPOSES ONLY.	APPROVED BY:	DATE:				L
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# **Reliability Test**

Test Items	Specifications	Test Method and Remarks
Operating temperature range	-40°C to +125°C	Including temperature rise due to self-generated heat
Storage condition	Ambient temperature : 0°C to 40°C Humidity : Below 70%RH	To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.
Moisture sensitivity	Appearance: No abnormality No damageDCR change: Within ±20%Inductance change: Within ±20%	According to J-STD-020B level 3 Test condition : 60°C 60% RH Test duration : 40 hours Recovery : 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.
Solderability	All termination shall exhibit a continuous solder coating free from defects for a minimum of 90% of the surface area of any individual lead.	According to J-STD-002B         Steam aging category       : 97°C 98% RH         Steam aging duration       : 8 hours         Solder       : Lead-free solder         Solder temperature       : 260 ±5°C         Dip time       : 5 +0/-0.5 seconds.

## **Material List**

No.	Item	Material Description
1	Core	T2 DR12.7 x 5.6 C B5.8 F3.3
2	Wire	Ø0.23mm x 1P 2UEWF 155°C
3	Solder (Lead Free)	Sn99.3% / Cu0.7%
4	Glue	TH320
5	Base	DAP HD 127-3

### Part Number Table

 Description
 Part Number

 Inductor, 1MH, 20%, SMD
 MCBF7330-102MU

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